Aerospace & Defense Solutions

Specialized products, processes, and services from ON Semiconductor.
Trusted Source

With headquarters in Phoenix, Arizona, and on-shore design and manufacturing centers, ON Semiconductor offers a secure, stable environment for the development of advanced semiconductor solutions for aerospace and defense applications.

ON Semiconductor has been granted Category 1A Trusted Design, Trusted Test, and Trusted Foundry accreditation by the Defense Microelectronics Activity (DMEA), enabling trusted support from design through product shipment. The Trusted Foundry accreditation allows ON Semiconductor to support its digital and mixed signal designs at the 40,000 square foot (ft\(^2\)) clean room manufacturing space in Pocatello, ID, as well as the Gresham, OR, 100,000 ft\(^2\) clean room. The accreditation program is part of the DoD strategy to ensure that electronic components used in U.S. military and national security applications are trustworthy and secure. An assured “chain of custody”, supply chain integrity, and prevention of tampering are critical for Application Specific Integrated Circuits (ASIC) used by national security agencies. A key part of the Trusted Foundry program is that it uniquely provides the US Government with guaranteed access to leading edge trusted microelectronics services for low volume applications. ON Semiconductor’s accreditation confirms their commitment to meet these government requirements.

On Semiconductor has also been granted “Trusted Broker” accreditation by DMEA, enabling the company to support the entire trusted manufacturing process through engagement with other trusted suppliers. The combination of the four accreditations benefits military and defense customers by providing a fully integrated trusted manufacturing solution.

In addition, ON Semiconductor maintains ITAR certification and QML flows required for military designs.
Processes and Capabilities

ON Semiconductor is certified to the following process standards:

- MIL-PRF-38535
- MIL-STD-750
- IATF 16949
- AS 9100 Rev. D
- STACK
- ISO 9000
- QS9000
- TL9000
- ESCC-9020
- ESCC-2269000

Environmental Performance

ON Semiconductor provides robust silicon technologies for ASIC products that are characterized over an extended temperature range from cryogenic to 150°C, as well as a portfolio of plastic and hermetic packaging suitable for high reliability end applications.

Process Longevity

ON Semiconductor operates modularized wafer fabrication processes that enable the company to offer extended process lifetimes, meeting the market need for secure, long life-cycle processes to support long product lives of ten years or more. This approach also allows the company to support low volume requirements of aerospace and defense customers. An established, flexible EOL process enables adequate transition or EOL planning.
Radiation Hardened By Design Solutions

Robust ASICs for Aerospace Applications

ON Semiconductor offers Application Specific Integrated Circuit (ASIC) solutions critical for aerospace applications and products requiring rigorous FIT rates due to terrestrial radiation exposure. A combination of characterization test data, soft-error-aware design flow methodology, qualification, and handling flows allow customers multiple options in planning and designing ASICs in a wide variety of applications. Available in the company’s 110 nm and 180 nm digital processes, the standard cell and SRAM architectures achieved superior neutron test results across voltage and temperature. To further reduce Single Event Effects (SEE), the design offering includes enhanced substrates, redundancy and error correction code (ECC) options. Leveraging the company’s existing commercial digital ASIC flow, customers benefit from superior pricing, development spans and manufacturing cycle times.

<table>
<thead>
<tr>
<th>ONC18 FIT (Sea Level, NYC)</th>
<th>1.8 V FIT Per M Bit</th>
<th>1.5 V FIT Per M Bit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Dual Port SRAM</td>
<td>618</td>
<td>778</td>
</tr>
<tr>
<td>Single Port SRAM</td>
<td>492</td>
<td>704</td>
</tr>
<tr>
<td>Flip Flop*</td>
<td>313</td>
<td>529</td>
</tr>
</tbody>
</table>

* Single bit FIT only. Redundancy will significantly reduce FIT.
No SEL at 85°C, 1.93 V.
No MBU or SEFI.

<table>
<thead>
<tr>
<th>ONC110 FIT (Sea Level, NYC)</th>
<th>1.20 V FIT Per M Bit</th>
</tr>
</thead>
<tbody>
<tr>
<td>HDSP SRAM</td>
<td>360</td>
</tr>
<tr>
<td>DP SRAM</td>
<td>290</td>
</tr>
<tr>
<td>Flip Flop*</td>
<td>358</td>
</tr>
</tbody>
</table>

* Single bit FIT only. Redundancy will significantly reduce FIT.
No SEL at 125°C, 1.26 V.
No MBU or SEFI.

Soft Error Mitigation Solutions for Aerospace

ON Semiconductor has a wide range of design solutions to mitigate soft errors while taking density, power, and performance into account. A combination of proven Rad Hard by Design (RHBD) techniques and process enhancements deliver outstanding neutron test results. Be it partial, sequential, or full Triple Modular Redundancy (TMR), ON Semiconductor can tailor an ASIC development flow to meet the design and application needs of a wide range of aerospace applications.
Radiation Hardened By Design Solutions

Robust ASICs for Space and High Reliability Applications
ON Semiconductor offers Radiation Hardened by Design (RHBD) solutions critical for space and Hi-Rel applications. Available in the company’s 110 nm digital Application Specific Integrated Circuit (ASIC) processes, the design offering includes a novel flip-flop architecture called Self Restoring Logic (SRL). SRL remains hard to single event effects at high Linear Energy Transfer (LET) while operating up to 700 MHz, far exceeding the capability of legacy RHBD flip-flop architectures. A latch-up resistant Dual Port SRAM with on-board error correction code (ECC), hardened clock elements, high-speed I/O cells, and a single event latch up protection cell expand the design portfolio. These cells are compatible with the existing digital ASIC flows resulting in superior pricing, development spans and manufacturing cycle times.

ONC110 Test Results

<table>
<thead>
<tr>
<th>Test Category</th>
<th>Specification Details</th>
</tr>
</thead>
<tbody>
<tr>
<td>Total Ionizing Dose (Si)</td>
<td>300 kRads</td>
</tr>
<tr>
<td>SRL Onset LET (700 MHz)</td>
<td>107 Mev cm²/mg (Si)</td>
</tr>
<tr>
<td>SEL Tolerant</td>
<td>Tested to 125 Mev cm²/mg (Si) at 150°C and Vdd +10%</td>
</tr>
<tr>
<td>Dose Rate Upset</td>
<td>Tested to 1 x 10⁹ rad(si)/s</td>
</tr>
<tr>
<td>Dose Rate Latch-Up</td>
<td>Tested to 3 x 10⁸ rad(si)/s</td>
</tr>
<tr>
<td>Neutron SEE</td>
<td>8 x 10¹³ n/cm² (1 MeV equivalent)</td>
</tr>
</tbody>
</table>

Proven Rad-Hard Solutions for Space
ON Semiconductor has a wide range of design solutions to mitigate radiation effects. Hardened IP and a proven commercial ASIC development flow combine to achieve results that meet the design and application needs of a wide range of applications. The company's ASIC legacy spans five decades and includes thousands of design-from-spec, customer interactive, and FPGA conversion success stories. The addition of 110 nm RHBD capabilities enables ON Semiconductor to expand our ASIC heritage and service the needs of existing and new customers.


Product Processing

Special Packaging
- Custom package developments
- Drop in replacement for ASICs / FPGAs
  - No need to modify the board footprint
- Aerospace / defense packaging
  - From ceramic packages to complex flip-chip BGAs
  - On-shore assembly and test capabilities
  - Thermally enhanced packages

Extended Temperature
- ON Semiconductor supports extended temperature in several technologies
  - -55 to +125°C for 0.5 µm and 0.35 µm process technology
  - -55 to +150°C for 180 nm process technology
  - -55 to +150°C for 110 nm process technology

Security Capability
- ON Semiconductor partners with third party IP providers
- Offers anti-tamper, error correction, and encryption capabilities with third parties

Avionics
- Demonstrated SEL immunity
- Soft error rate data available for logic and memories for 110 nm and 180 nm process technologies

Non-Volatile Memory
- 0.5 µm and 0.35 µm process technologies offer up to 1 kb EEPROM with a maximum configuration of 32 x 32; temperature ranges vary
- ONC18 (180 nm) offers two memory options
  - One Time Programmable (OTP) up to 256 kb; -40 to +125°C
  - EE Array up to 1 kb
- SP110 (110 nm) capable of supporting OTP
  - -40 to +125°C up to 312 kb

Energy Efficient Innovations

Aerospace & Defense Solutions
Advanced Processes and Intellectual Property

Digital Standard Cell Product Families

<table>
<thead>
<tr>
<th>Standard Cell Product Families</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Family</strong></td>
</tr>
<tr>
<td>SC5 0.5 μm</td>
</tr>
<tr>
<td>SC3 0.35 μm</td>
</tr>
<tr>
<td>ONC18 180 nm</td>
</tr>
<tr>
<td>SP110 110 nm</td>
</tr>
<tr>
<td>SP65/55 65 nm, 55 nm</td>
</tr>
<tr>
<td>SP45/40 45 nm, 40 nm</td>
</tr>
<tr>
<td>SP32/28 32 nm, 28 nm</td>
</tr>
<tr>
<td>GF22 FDX/FDSOI</td>
</tr>
</tbody>
</table>

Comprehensive Intellectual Property Offering

ON Semiconductor offers a suite of system IP suitable for a variety of applications, including those requiring high-speed serial I/O (SerDes), external high performance memory interfaces, processors and a variety of other hard and soft IP. Combined with support for a rich family of I/O standards, our digital ASIC technologies and IP provide optimal solutions for aerospace/defense, automotive, communications, industrial, consumer, computing, and medical applications. ON Semiconductor is an Arm® microprocessor licensee, and has access to multiple Arm cores for integration into silicon products.
Custom ASIC Designs

Digital solutions from 0.5 μm to 28 nm

- Flexible ASIC design interfaces including whole or partial RTL, Netlist, and GDSII content
- Robust FPGA proof-of-concept validation flow when targeting an ASIC
- FPGA-to-ASIC, ASIC-to-ASIC, and multi-chip-to-ASIC conversions
- EOL support with ASIC-to-ASIC conversion approach
- Big D (Digital) / Small A (Analog) ASIC capability to increase integration and simplify board design
- Up to 50 million gates and 50 Mb of memory
- System architects to advise on best overall solution
- Proven technologies to ensure long term, continuous supply
- Secure supply with domestic manufacturing
- Support for long-life, small volume applications
- High reliability, high temperature, special packaging and handling
- Complete solutions including product development, test, package engineering, quality engineering, and failure analysis
- Full ITAR handling available
- QML Flow, Trusted Supplier
- DO-254 compliance support
- Custom packaging capability to match most pin-outs and package types
High Performance Image Sensors

With over 40 years of imaging expertise, ON Semiconductor is a leading supplier of high performance CCD and CMOS image sensors. Our broad portfolio of products includes devices with resolutions ranging from VGA to over 50 megapixels supported by pixel sizes that span from 1 to 24 microns. And our advanced design and processing techniques can be utilized in the development of custom CCD and CMOS products specifically designed to address the most demanding imaging applications.

Broad Portfolio of Standard Devices

- Rolling and Global Shutter CMOS for high speed, low power, and readout flexibility
- Full Frame and Interline Transfer CCD for high dynamic range, low noise, and excellent image uniformity
- Interline Transfer EMCCD for very low light imaging (to moonlight or starlight)
- Radiation tolerant designs for use in high radiation environments

Advanced Technology Base

- CCD and CMOS pixel designs
- Electron Multiplication
- High-speed readout architectures
- CMOS Backside Illumination
- SOC integration
- Specialized Color Filter Array (CFA) configurations
- Dedicated co-processors
- Military qualification grades available
- Custom TDI linear image sensor design experience for Remote Sensing applications
Integrated Passive Devices (IPD) – Efficient RF System-in-Package Solutions

Integrating passive devices into our HighQ™ copper platform gives a cost-effective, space-saving solution for all RF needs.

**IPD Technology Characteristics**
- Target frequency: 500 MHz to 40 GHz
- Low profile, minimal footprint
- Tight tolerance

**Typical Applications**
- Power amplifiers
- Antenna switch modules
- Electronic countermeasures
- Software defined/cognitive radio

**Typical IPD Designs**
- Baluns
- Couplers
- Diplexers
- Balanced Filters
- Splitters
- Matching networks

**IPD Technology (R, L, C)**

**Performance**
- Guaranteed ±5.0% capacitor tolerance
- Typical < 1% variance between capacitors on common IPD
- Dual Cu stack up of 12 µm for high Q inductors

![Thickest Inductors in the Industry](image1)

High Resistivity Silicon Substrate

Optional Resistors

High Tolerance Caps

MIM (SiN)

Insulating Oxide

Dual Copper Stackup with Full Length Stitched Via
IPD Technology

Advantages

• Smaller than discrete solutions
• Thinner & higher precision than LTCC
• Lower cost than GaAs
• Best performance among silicon-based IPDs

State of the Art Fab

• Standard Mechanical InterFace system (SMIF) results in high and consistent yields
• Located in Gresham, Oregon
• Fab Certifications:
  » ISO 14001  » QML (DoD)
  » IATF 16949  » ITAR (DoD)
  » AS 9100 Rev. D  » Trusted Foundry Status
  » OHSAS-18001

Design and Foundry Services

• Complimentary feasibility study
• Design services available
• Self-service design with full featured PDK for Cadence and Agilent
• Four 8-inch dedicated prototype wafers
• Shuttles with multiple designs/variants
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